

10-23-2001

ATTORNEY DOCKET NO: M-11316 US



U.S. DEPARTMENT OF COMMERCE  
PATENT AND TRADEMARK OFFICE

SHEET  
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TO THE HONORABLE DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE. PLEASE RECORD THE ATTACHED ORIGINAL DOCUMENTS OR COPY THEREOF.

1. Name of conveying party(ies):  
  
(a) Young Wook Heo  
Additional name(s) of conveying party(ies) attached? 10/09/01  
 Yes  No

2. Name and address of receiving party(ies):  
  
Name: Amkor Technology, Inc.  
Street Address: 1900 South Price Road  
City: Chandler AZ 85248-1604  
Country: U.S.A.

3. Nature of Conveyance:  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_  
Execution Date: October 8, 2001

Name and address of receiving party(ies):  
  
Name: {Enter Name}  
Street Address: {Enter Street Address}  
City: {City} State: {State} Zip: {Zip}  
Country: {Country}  
Additional name(s) & address(es) attached?  
 Yes  No

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application, the execution date of the application is: October 8, 2001

A. Patent Application No.(s) - {Patent Application Numbers}  
Title: Semiconductor Package Having Stacked Semiconductor Chips And Method Of Making The Same

B. Patent No.(s)

09974541 Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: James E. Parsons  
Internal Address: SKJERVEN MORRILL MacPHERSON LLP  
Street Address: 25 METRO DRIVE, SUITE 700  
City SAN JOSE State CA Zip 95110

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41): \$40.00  
 Authorized to be charged to Deposit Account 19-2386  
 Charge Deposit Account 19-2386 for any additional fees required for this conveyance and credit deposit account 19-2386 any amounts overpaid

DO NOT USE THIS SPACE

8. Statement and signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*  
  
James E. Parsons 34,691 James E. Parsons October 9, 2001  
Name of Person Signing Signature Date  
Total number of pages including cover sheet, attachments, and documents: 2

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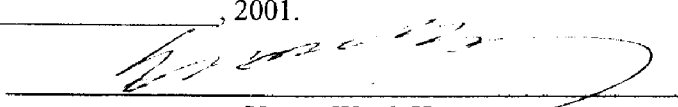
PATENT  
REEL: 012259 FRAME: 0920

**ASSIGNMENT**

For good and valuable consideration, receipt of which is hereby acknowledged, I, Heo, Young Wook of Pheonix, AZ 85048, hereby sell, assign and transfer to Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 South Price Road, Chandler, AZ 85248-1604, its successors and assigns, the entire right, title and interest throughout the world in my invention in

**SEMICONDUCTOR PACKAGE HAVING STACKED SEMICONDUCTOR CHIPS AND METHOD OF MAKING THE SAME**

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request that the United States Patent and Trademark Office issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this 5 day of Oct, 2001.  
  
Young Wook Heo

State of Arizona )  
County of Maricopa ) ss.

On 10/8/01 before me, Sharon L. Hosford personally appeared Young Wook Heo personally known to me or proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is(are) subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

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